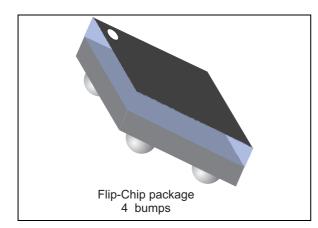


BAL-CC25-01D3

Datasheet – production data

50 ohm, conjugate match to CC253x, CC254x, CC257x, CC852x, CC853x, transformer balun



Features

- 2.45 GHz balun with integrated matching network
- Matching optimized for following chip-sets:
 - CC2530, CC2531, CC2533
 - CC2540, CC2541, CC2541S
 - CC2543, CC2544, CC2545
 - CC2570, CC2571
 - CC8520, CC8521
 - CC8530, CC82531
- Low insertion loss
- Low amplitude imbalance
- Low phase imbalance
- Coated Flip-Chip on glass
- Small footprint: < 0.88 mm²

Benefits

- Very low profile
- High RF performance
- PCB space saving versus discrete solution
- BOM count reduction
- Efficient manufacturability

Description

STMicroelectronics BAL-CC25-01D3 is an ultra miniature balun which integrates a matching network in a monolithic glass substrate. This has been customized for the CC25xx and CC85xx RF transceivers.

It's a design using STMicroelectronics IPD (integrated passive device) technology on nonconductive glass substrate to optimize RF performance.

Figure 1. Pin configuration (top view)

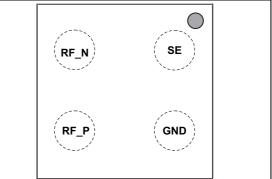
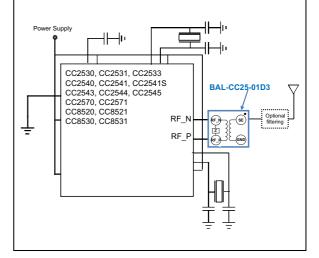


Figure 2. Application schematic (top view)



May 2013

DocID024657 Rev 1

1/9

This is information on a product in full production.

1 Characteristics

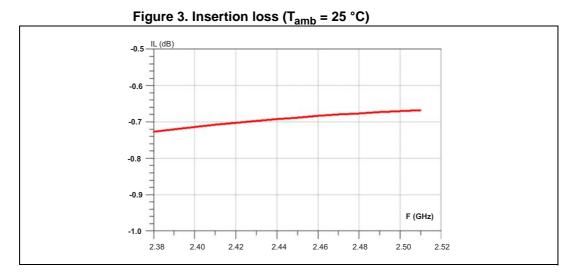
Symbol	Parameter	Value			Unit
	Falameter		Тур.	Max.	Onit
P _{PEAK}	Input power RF _{IN}		20		dBm
V _{ESD}	ESD ratings MIL STD883C (HBM: C = 100 pF, R = 1.5 Ω , air discharge)	2000			
	ESD ratings machine model (MM: C = 200 pF, R = 25 Ω , L = 500 nH)	500			V
	ESD ratings charged device model (CDM, JESD22-C101D)	500			
Т _{ОР}	Operating temperature	-40		+125	°C

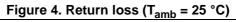
Table 1. Absolute maximum rating (limiting values)

Table 2. Electrical characteristics - RF performance (T_{amb} = 25 °C)

Symbol	Parameter		Unit			
Cymbol	i urumotor	Min.	Тур.	Max.	onit	
Z _{OUT}	Nominal differential output impedance	Conjugate match to CC25xx,		Ω		
Z _{IN}	Nominal input impedance	CC85xx				
F	Frequency range (bandwidth)	2379		2507		
۱ _L	Insertion loss in bandwidth		0.66		dB	
R _{L_SE}	Single ended return loss in bandwidth		19		dB	
R _{L_DIFF}	Differential ended return loss in bandwidth		19		dB	
Φ_{imb}	Phase imbalance		14		o	
A _{imb}	Amplitude imbalance		0.3		dB	







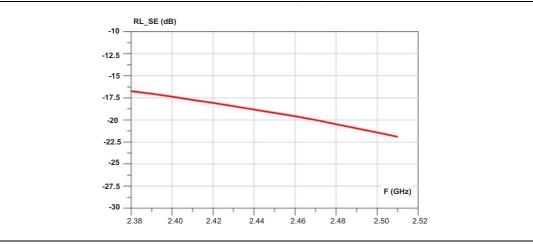
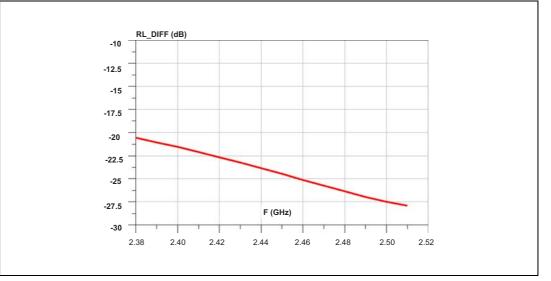
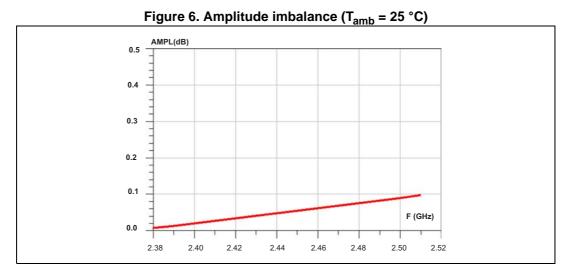


Figure 5. Return loss (T_{amb} = 25 °C)

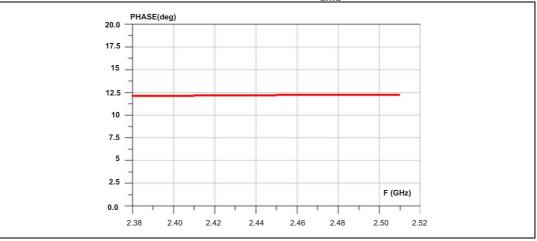




DocID024657 Rev 1



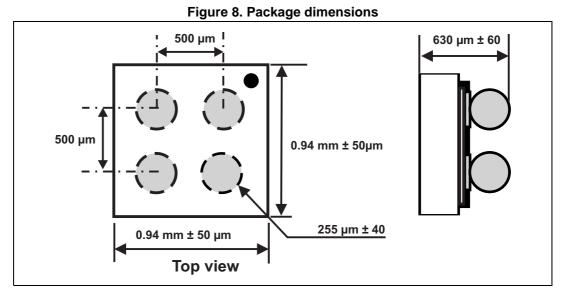


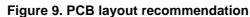


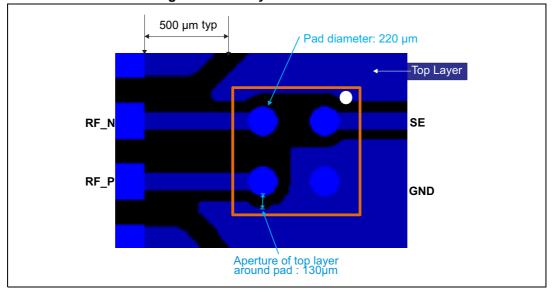


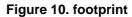
2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com.* ECOPACK[®] is an ST trademark.









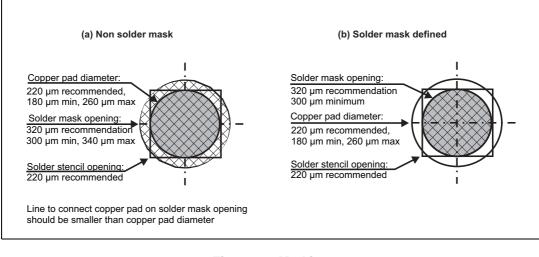
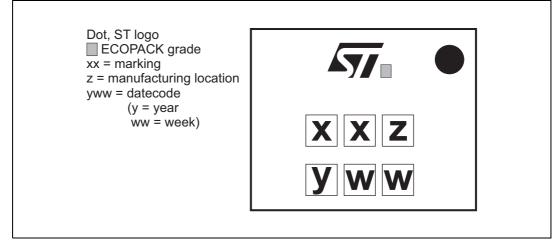


Figure 11. Marking





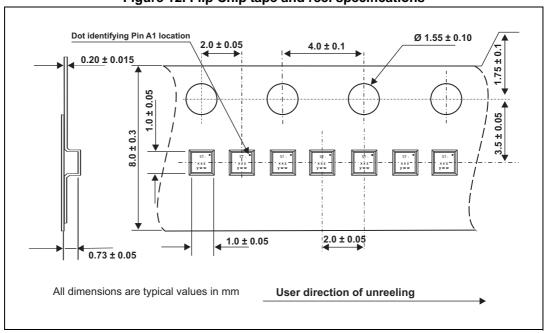
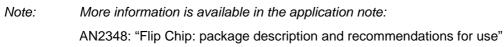


Figure 12. Flip Chip tape and reel specifications





3 Ordering information

Table 3	. Ordering	information
---------	------------	-------------

Order code	Marking	Package	Weight	Base qty	Delivery mode
BAL-CC25-01D3	SL	Flip Chip	1.07 mg	5000	Tape and reel (7")

4 Revision history

Date	Revision	Changes
23-May-2013	1	Initial release



Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

ST PRODUCTS ARE NOT AUTHORIZED FOR USE IN WEAPONS. NOR ARE ST PRODUCTS DESIGNED OR AUTHORIZED FOR USE IN: (A) SAFETY CRITICAL APPLICATIONS SUCH AS LIFE SUPPORTING, ACTIVE IMPLANTED DEVICES OR SYSTEMS WITH PRODUCT FUNCTIONAL SAFETY REQUIREMENTS; (B) AERONAUTIC APPLICATIONS; (C) AUTOMOTIVE APPLICATIONS OR ENVIRONMENTS, AND/OR (D) AEROSPACE APPLICATIONS OR ENVIRONMENTS. WHERE ST PRODUCTS ARE NOT DESIGNED FOR SUCH USE, THE PURCHASER SHALL USE PRODUCTS AT PURCHASER'S SOLE RISK, EVEN IF ST HAS BEEN INFORMED IN WRITING OF SUCH USAGE, UNLESS A PRODUCT IS EXPRESSLY DESIGNATED BY ST AS BEING INTENDED FOR "AUTOMOTIVE, AUTOMOTIVE SAFETY OR MEDICAL" INDUSTRY DOMAINS ACCORDING TO ST PRODUCT DESIGN SPECIFICATIONS. PRODUCTS FORMALLY ESCC, QML OR JAN QUALIFIED ARE DEEMED SUITABLE FOR USE IN AEROSPACE BY THE CORRESPONDING GOVERNMENTAL AGENCY.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries. Information in this document supersedes and replaces all information previously supplied. The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2013 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com



DocID024657 Rev 1